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International **ICR** Rectifier Preliminary Data Sheet No. PD60131 revM

IR21531(D)(S)&(PbF)

SELF-OSCILLATING HALF-BRIDGE DRIVER

Features

- Integrated 600V half-bridge gate driver
- 15.6V zener clamp on Vcc
- True micropower start up
- Tighter initial deadtime control
- Low temperature coefficient deadtime
- Shutdown feature (1/6th Vcc) on CT pin
- Increased undervoltage lockout Hysteresis (1V)
- Lower power level-shifting circuit
- Constant LO, HO pulse widths at startup
- Lower di/dt gate driver for better noise immunity
- Low side output in phase with RT
- Internal 50nsec (typ.) bootstrap diode (IR21531D)
- Excellent latch immunity on all inputs and outputs
- ESD protection on all leads
- Also available LEAD-FREE

Description

The IR21531(D)(S) are an improved version of the popular IR2155 and IR2151 gate driver ICs, and in-

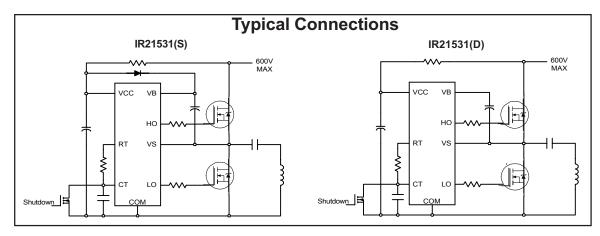
Product Summary

| VOFFSET | 600V max. |
|--------------------|-----------|
| Duty Cycle | 50% |
| Tr/Tp | 80/40ns |
| V _{clamp} | 15.6V |
| Deadtime (typ.) | 0.6 µs |

Packages



corporates a high voltage half-bridge gate driver with a front end oscillator similar to the industry standard CMOS 555 timer. The IR21531 provides more functionality and is easier to use than previous ICs. A shutdown feature has been designed into the C_T pin, so that both gate driver outputs can be disabled using a low voltage control signal. In addition, the gate driver output pulse widths are the same once the rising undervoltage lockout threshold on V_{CC} has been reached, resulting in a more stable profile of frequency vs time at startup. Noise immunity has been improved significantly, both by lowering the peak di/dt of the gate drivers, and by increasing the undervoltage lockout hysteresis to 1V. Finally, special attention has been payed to maximizing the latch immunity of the device, and providing comprehensive ESD protection on all pins.



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Min. | Max. | Units | | |
|---------------------|---|------|----------------------|-----------------------|-------|--|
| VB | High side floating supply voltage | | -0.3 | 625 | | |
| Vs | High side floating supply offset voltage | | V _B - 25 | V _B + 0.3 | | |
| V _{HO} | High side floating output voltage | | V _S - 0.3 | V _B + 0.3 | | |
| V _{LO} | Low side output voltage | | -0.3 | V _{CC} +0.3 | V | |
| V _{RT} | R _T pin voltage | | -0.3 | V _{CC} + 0.3 | | |
| VCT | C _T pin voltage | | -0.3 | V _{CC} + 0.3 | | |
| lcc | Supply current (note 1) | | | 25 | mA | |
| I _{RT} | R _T pin current | | -5 | 5 | 111/5 | |
| dV _s /dt | Allowable offset voltage slew rate | | -50 | 50 | V/ns | |
| PD | Maximum power dissipation @ $T_A \le +25^{\circ}C$ (8 Lead DIP) | | | 1.0 | W | |
| | (8 Lead SOIC) | | | 0.625 | - vv | |
| Rth _{JA} | Thermal resistance, junction to ambient (8 Lead DIP) | | | 125 | °C/// | |
| | (8 Lead SOIC) | | | 200 | °C/W | |
| TJ | Junction temperature | | -55 | 150 | | |
| Τ _S | Storage temperature | | -55 | 150 | °C | |
| ΤL | Lead temperature (soldering, 10 seconds) | | _ | 300 | | |

Recommended Operating Conditions

For proper operation the device should be used within the recommended conditions.

| Symbol | Definition | Min. | Max. | Units |
|-----------------|---|-----------------------|--------|-------|
| V _{BS} | High side floating supply voltage | V _{CC} - 0.7 | VCLAMP | |
| Vs | Steady state high side floating supply offset voltage | -3.0 (note 2) | 600 | V |
| V _{CC} | Supply voltage | 10 | VCLAMP | |
| lcc | Supply current | (note 3) | 5 | mA |
| Тj | Junction temperature | -40 | 125 | °C |

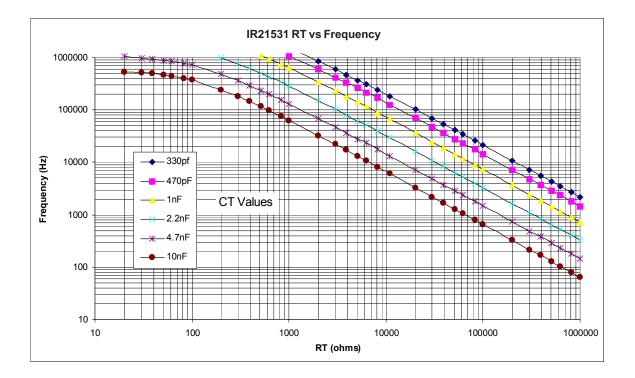
Note 1: This IC contains a zener clamp structure between the chip V_{CC} and COM which has a nominal breakdown voltage of 15.6V. Please note that this supply pin should not be driven by a DC, low impedance power source greater than the V_{CLAMP} specified in the Electrical Characteristics section.

Note 2: Care should be taken to avoid output switching conditions where the V_S node flies inductively below ground by more than 5V.

Note 3: Enough current should be supplied to the V_{CC} pin of the IC to keep the internal 15.6V zener diode clamping the voltage at this pin.

Recommended Component Values

| Symbol | Component | Min. | Max. | Units |
|--------|------------------------------------|------|------|-------|
| RT | Timing resistor value | 10 | | kΩ |
| CT | C _T pin capacitor value | 330 | — | pF |



Electrical Characteristics

 V_{BIAS} (V_{CC}, V_{BS}) = 12V, C_L = 1000 pF, C_T = 1 nF and T_A = 25°C unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

| Low Vo | Itage Supply Characteristics | | | | | |
|--------------------|---|------|-------|------|-------|--|
| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
| V _{CCUV+} | Rising V _{CC} undervoltage lockout threshold | 8.1 | 9.0 | 9.9 | | |
| V _{CCUV-} | Falling V _{CC} undervoltage lockout threshold | 7.2 | 8.0 | 8.8 | V | |
| VCCUVH | V _{CC} undervoltage lockout Hysteresis | 0.5 | 1.0 | 1.5 | 1 | |
| IQCCUV | Micropower startup V _{CC} supply current | | 75 | 150 | | Vcc≤Vccuv- |
| IQCC | Quiescent V _{CC} supply current | | 500 | 950 | μΑ | |
| VCLAMP | V _{CC} zener clamp voltage | 14.4 | 15.6 | 16.8 | V | I _{CC} = 5mA |
| Floatin | g Supply Characteristics | | | | · | · |
| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
| IQBSUV | Micropower startup V _{BS} supply current | _ | 0 | 10 | | V _{CC} ≤V _{CCUV} - |
| I _{QBS} | Quiescent VBS supply current | _ | 30 | 50 | μΑ | |
| V _{BSMIN} | Minimum required V_{BS} voltage for proper functionality from R_T to HO | _ | 4.0 | 5.0 | V | V _{CC} =V _{CCUV+} + 0.1V |
| ILK | Offset supply leakage current | _ | _ | 50 | μA | $V_{\rm B} = V_{\rm S} = 600 V$ |
| VF | Bootstrap diode forward voltage (IR21531D) | 0.5 | _ | 1.0 | V. | IF = 250mA |
| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
| fosc | Oscillator frequency | 19.4 | 20 | 20.6 | kHz | R _T = 36.9kΩ |
| | . , | 94 | 100 | 106 | KIIZ | RT = 7.43kΩ |
| d | RT pin duty cycle | 48 | 50 | 52 | % | fo < 100kHz |
| ICT | CT pin current | | 0.001 | 1.0 | uA | |
| ICTUV | UV-mode CT pin pulldown current | 0.30 | 0.70 | 1.2 | mA | V _{CC} = 7V |
| V _{CT+} | Upper C _T ramp voltage threshold | _ | 8.0 | — | | |
| Vct- | Lower CT ramp voltage threshold | — | 4.0 | — | V | |
| VCTSD | CT voltage shutdown threshold | 1.8 | 2.1 | 2.4 | | |
| V _{RT+} | High-level RT output voltage, VCC - VRT | — | 10 | 50 | | I _{RT} = 100μΑ |
| | | — | 100 | 300 | | I _{RT} = 1mA |
| Vrt- | Low-level RT output voltage | _ | 10 | 50 | | I _{RT} = 100μA |
| | | _ | 100 | 300 | mV | I _{RT} = 1mA |
| Vrtuv | UV-mode RT output voltage | _ | 0 | 100 | | $V_{CC} \le V_{CCUV}$ |
| VRTSD | SD-Mode RT output voltage, VCC - VRT | _ | 10 | 50 | | I _{RT} = 100μA, V _{CT} = 0V |
| | | _ | 10 | 300 | - | $I_{RT} = 1mA,$ $V_{CT} = 0V$ |

Electrical Characteristics (cont.)

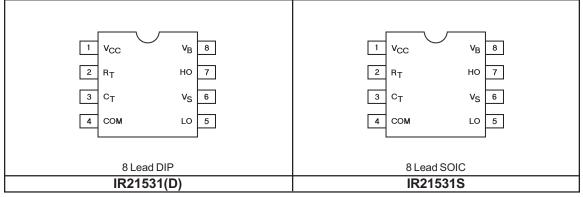
Gate Driver Output Characteristics

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|-----------------------------------|--------------------------------------|------|------|------|-------|--------------------------------------|
| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
| Voh | High level output voltage, VBIAS -VO | _ | 0 | 100 | | I _O = OA |
| VOL | Low-level output voltage, VO | _ | 0 | 100 | mV | I _O = OA |
| VOL_UV | UV-mode output voltage, VO | _ | 0 | 100 |] | I _O = OA |
| | | | | | | V _{CC} ≤V _{CCUV} - |
| tr | Output rise time | _ | 80 | 150 | | |
| tf | Output fall time | — | 45 | 100 | nsec | |
| t _{sd} | Shutdown propogation delay | _ | 660 | — | T | |
| td | Output deadtime (HO or LO) | 0.35 | 0.60 | 0.85 | μsec | |

Lead Definitions

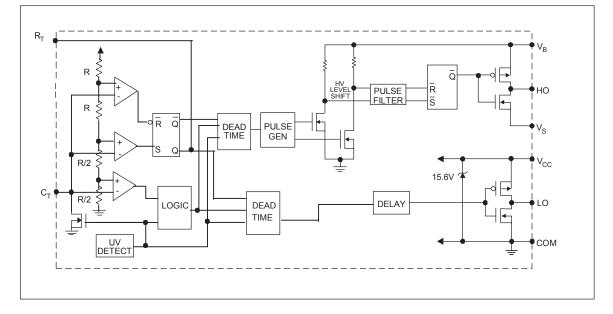
| Symbol | Description |
|-----------------|--|
| V _{CC} | Logic and internal gate drive supply voltage |
| R _T | Oscillator timing resistor input |
| CT | Oscillator timing capacitor input |
| COM | IC power and signal ground |
| LO | Low side gate driver output |
| Vs | High voltage floating supply return |
| НО | High side gate driver output |
| VB | High side gate driver floating supply |

Lead Assignments

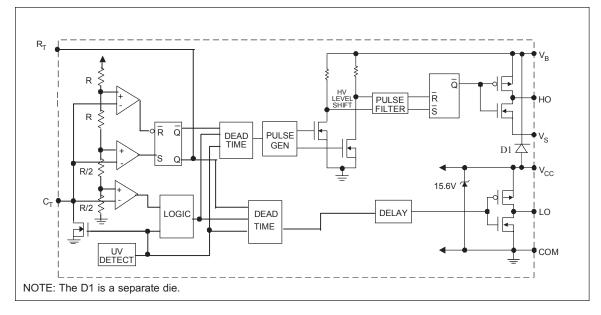


NOTE: The IR21531D is offered in 8 lead DIP only.

Functional Block Diagram for IR21531(S)

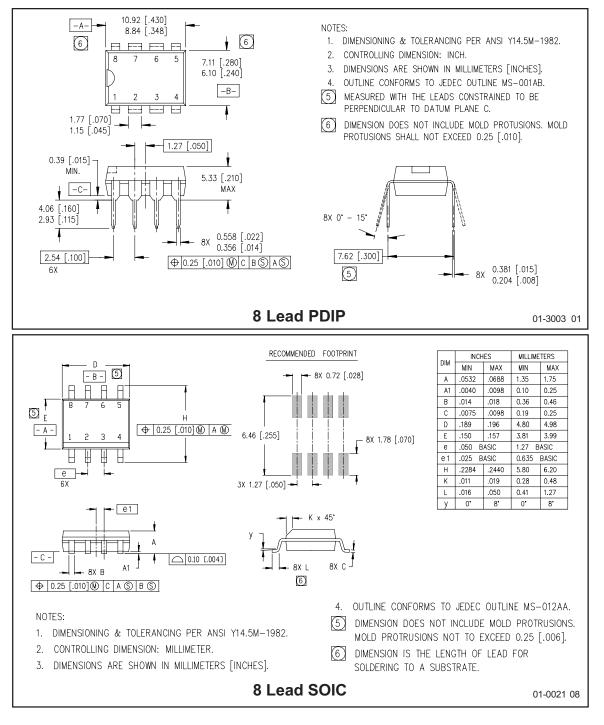


Functional Block Diagram for IR21531D



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IR21531(D)(S)&(PbF)



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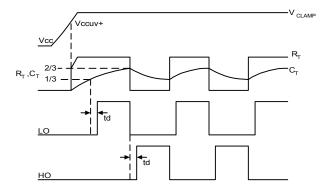


Figure 1. Input/Output Timing Diagram

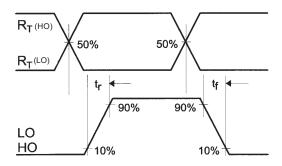


Figure 2. Switching Time Waveform Definitions

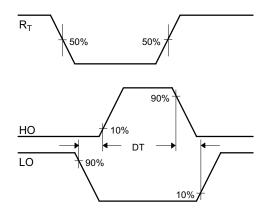
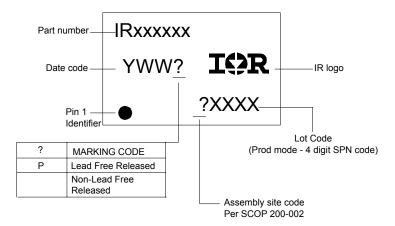


Figure 3. Deadtime Waveform Definitions

LEADFREE PART MARKING INFORMATION



ORDER INFORMATION

Basic Part (Non-Lead Free)

8-Lead PDIP IR21531 order IR21531 8-Lead SOIC IR21531S order IR21531S 8-Lead PDIP IR21531D order IR21531D

Leadfree Part

8-Lead PDIP IR21531 order IR21531PbF 8-Lead SOIC IR21531S order IR21531SPbF 8-Lead PDIP IR21531D order IR21531DPbF

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